

High PSRR, low drop linear regulator IC





DFN6 (2x2)



DFN6 (3x3)

Features

- Input voltage from 2.5 V to 18 V
- 20 V AMR
- Any fixed output voltages, from 1.2 V to 12 V in 100 mV steps (from 1.2 V to 6.6 V in 50 mV steps) available on request
- Adjustable version from 1.18 V to V_{IN} V_{DROP(MAX)}
- Guaranteed output current 1.2 A
- Typical dropout 350 mV @ 1.2 A
- · Undervoltage lockout
- Enable function
- Internal thermal, current and power limitation
- High PSRR: 87 dB @ 120 Hz, 75 dB @ 1 kHz
- Operating temperature range: -40 °C to 125 °C
- Packages SO-8 batwing plastic micropackage, DFN6 (3x3) and DFN6 (2x2)

Applications

- Consumer
- Industrial
- SMPS
- Point-of-load
- · DC-DC post-regulation

Maturity status link

LDL212

Description

The LDL212 provides 1.2 A of maximum current from an input voltage range from 2.5 V to 18 V, with a typical dropout voltage of 350 mV @ 1.2 A.

The high power supply rejection ratio of 87 dB at 120 Hz, and more than 40 dB at 100 kHz, makes the LDL212 suitable for direct regulation in SMPS and secondary linear regulation in DC-DC converters. The LDL212 goes to shutdown mode due to the enable logic control function, reducing the total current consumption.

The device also includes the current limit, SOA and thermal protections.



1 Block diagram

 V_{OUT} UVLO SENSE RC generator filte r OP-AMP ¢ EN Enable Thermal protection Bandgap Current and power lim it GND

Figure 1. Block diagram (fixed)

GIPD251120151438MT

V_{OUT} UVLO Bias RC generator filter OP-AMP ¢ EN Enable ADJ Thermal protection Bandgap reference Current and power limit GND

Figure 2. Block diagram (adjustable)

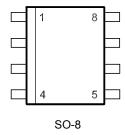
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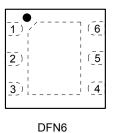
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2 Pin configuration

Figure 3. Pin configuration (top view)





GIPD261120151015MT

Table 1. Pin description

Pin name	Pin number (SO-8)	Pin number (DFN6)	Description
V _{IN}	4	4	Input voltage
V _{OUT}	1	3	Output voltage
GND	2, 3, 6, 7	1	Ground
ADJ/sense	8	2	Feedback pin for adjustable version / V _{OUT} sense on fixed version
EN	5	6	Enable pin. The device is in off-state when this pin is pulled low
NC	-	5	Not connected
GND	-	exposed pad	Exposed pad must be connected to GND

^{1.} The sense pin on the fixed version must be connected to $V_{\mbox{\scriptsize OUT}}$ for proper operation.

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3 Typical application

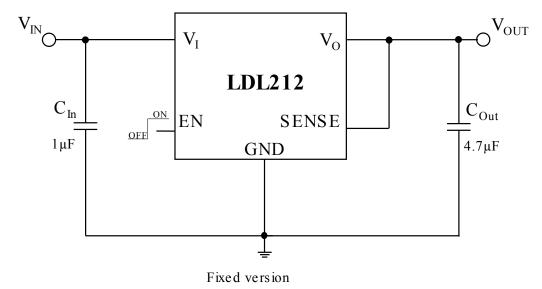
 V_{IN} C_{In} $I_{\mu F}$ O_{OEF} O_{ON} O_{ON}

Figure 4. Typical application circuit (adjustable version)

GIPD011220151346MT

Figure 5. Typical application circuit (fixed version)

Adjustable version



GIPD011220151347MT

Note: R1 and R2 are calculated according to the following formula: $R_1 = R_2 \times (V_{OUT}/V_{ADJ} - 1)$. The output voltage of the adjustable version can be set from 1.18 V to $V_{IN}-V_{DROP(MAX)}$, where $V_{DROP(MAX)}$ is the maximum dropout voltage, as defined in Table 4. Electrical characteristics.

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4 Maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{IN}	DC input voltage	- 0.3 to 20	V
V _{OUT}	DC output voltage	- 0.3 to V _{IN} + 0.3	V
V _{EN}	Enable input voltage	- 0.3 to V _{IN} + 0.3	V
V _{SENSE}	Output sense pin voltage	- 0.3 to V _{IN} + 0.3	V
V _{ADJ}	ADJ pin voltage	- 0.3 to 2	V
I _{OUT}	Output current	Internally limited	mA
P _D	Power dissipation	Internally limited	mW
T _{STG}	Storage temperature range	- 55 to 150	°C
T _{OP}	Operating junction temperature range	- 40 to 125	°C

Note:

Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
SO-8 batwing plastic micropackage	Thermal resistance junction-to-case	20	
	Thermal resistance junction-to-ambient	55	
DFN6 (2x2)	Thermal resistance junction-to-case	15	°C/W
	Thermal resistance junction-to-ambient	65	C/VV
DFN6 (3x3)	Thermal resistance junction-to-case	10	
	Thermal resistance junction-to-ambient	55	

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5 Electrical characteristics

 $T_{J} = 25~^{\circ}C,~V_{IN} = V_{OUT(NOM)} + 1~V,~C_{IN} = 1~\mu\text{F},~C_{OUT} = 4.7~\mu\text{F},~I_{OUT} = 10~\text{mA},~V_{EN} = V_{IN},~\text{unless otherwise specified.}$ (For $V_{OUT(NOM)} \le 1.5~V,~V_{IN} = 2.7~V.$)

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{IN}	Operating input voltage		2.5		18	V
V	Turn-on threshold			2.3	2.4	V
V_{UVLO}	Hysteresis			200		mV
		I _{OUT} = 10 mA				0/
W	V _{OUT} accuracy	T _J = 25 °C	-2		2	%
V _{OUT}	V _{OUT} accuracy	I _{OUT} = 10 mA				0/
		-40 °C < T _J < 125 °C	-3		3	%
		V _{IN} = 2.5 V, I _{OUT} = 10 mA		1.18		V
\/		T _J = 25 °C	-2		+2	%
V_{ADJ}	Adjustable pin voltage	V _{IN} = 2.5 V, I _{OUT} = 10 mA			. 0	0/
		-40 °C < T _J < 125 °C	-3		+3	%
I _{ADJ}	Adjustable pin current	V _{IN} = 2.5 V, I _{OUT} = 10 mA		20		nA
ΔV _{OUT}	Line regulation	V _{OUT} + 1 V ≤ V _{IN} ≤ 18 V, I _{OUT} = 10 mA		0.002	0.01	%/V
ΔV _{OUT}	Load regulation	I _{OUT} = 10 mA to 1.2 A		0.0001	0.0005	%/mA
.,	Dropout voltage (1)	I _{OUT} = 1.2 A V _{OUT} > 3 V		350	600	
V_{DROP}	Dropout voltage for SO-8 (1)	-40 °C < T _J < 125 °C			700	- mV
eN	Output noise voltage	10 Hz to 100 kHz, I _{OUT} = 100 mA		60		μV _{RMS} / V _{OUT}
		V _{IN} = V _{OUT(NOM)} + 1 V ± V _{RIPPLE}				
		V _{RIPPLE} = 0.5 V, f = 120 Hz		87		
		V _{IN} = V _{OUT(NOM)} + 1 V ± V _{RIPPLE}				
SVR	Supply voltage rejection	V _{RIPPLE} = 0.5 V, f = 1 kHz		75		dB
		V _{IN} = V _{OUT(NOM)} + 1 V ± V _{RIPPLE}				
		V _{RIPPLE} = 0.5 V, f = 100 kHz		50		
		I _{OUT} = 0 mA to 1.2 A				
		-40 °C < T _J < 125 °C		250	380	
IQ	Quiescent current	V _{IN} input current in OFF mode				μA
		V _{EN} = GND V _{IN} = 18 V		0.3	1.5	
I _{SC}	Short-circuit current	R _L = 0	1.5	2		Α
		V _{IN} = 2.5 V to 18 V				
V_{EN}	Enable input logic low	-40 °C < T _J < 85 °C		0.4		V
	Enable input logic high	V _{IN} = 2.5 V to 18 V	1.2			-

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{EN}		-40 °C < T _J < 85 °C				V
1	I _{EN} Enable input current			1.5		
IEN		V _{EN} = V _{IN} , V _{IN} = 18 V		16	20	μA
T _{ON}	Turn-on time (2)			120		μs
Тольы	Thermal shutdown			175		°C
T _{SHDN}	Hysteresis			25		-0

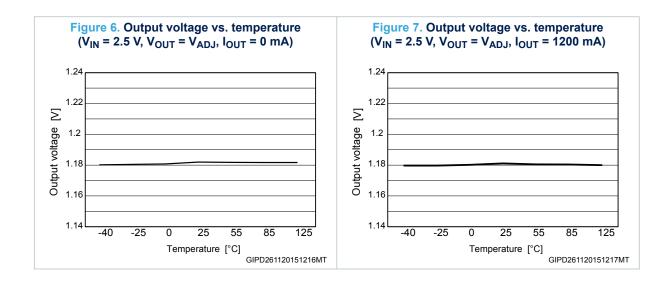
^{1.} Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value. This specification is not valid for output voltages below 2.2 V.

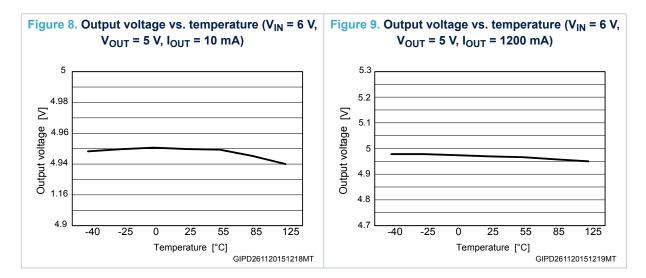
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^{2.} Turn-on time is the time measured between the enable input just exceeding V_{EN} high value and the output voltage just reaching 95% of its nominal value.



6 Typical performance characteristics

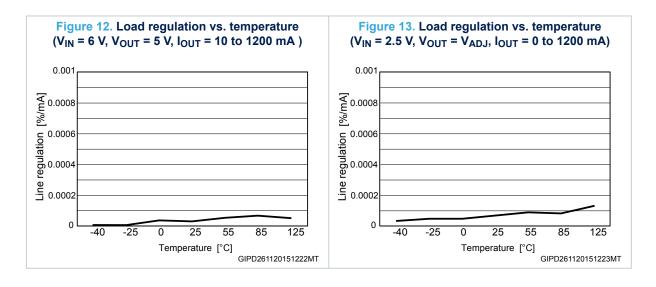


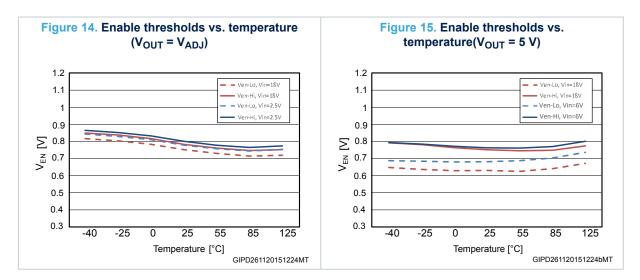


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Figure 10. Line regulation vs. temperature ($V_{IN} = 6$ Figure 11. Line regulation vs. temperature ($V_{IN} = 2.5$ to 18 V, V_{OUT} = 5 V, I_{OUT} = 10 mA) to 18 V, $V_{OUT} = V_{ADJ}$, $I_{OUT} = 10 \text{ mA}$) 0.04 0.03 J.L 0.025 % [%] Line regulation [0.005 0.005 Line regulation 0.02 0.005 0 -40 -25 0 25 55 85 125 Temperature [°C] Temperature [°C] GIPD261120151220MT GIPD261120151221MT





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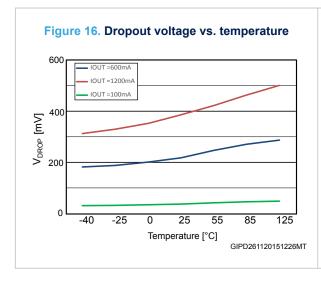
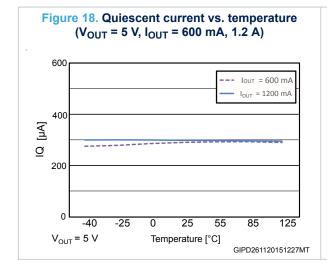
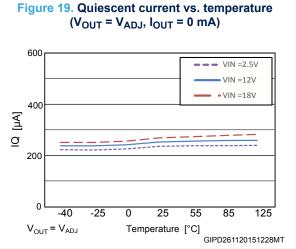
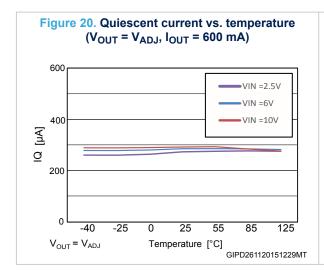
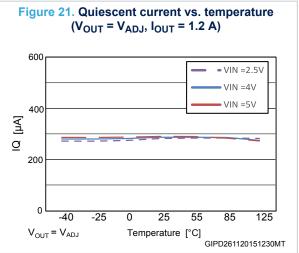


Figure 17. Quiescent current vs. temperature $(V_{OUT} = 5 V, I_{OUT} = 0 mA)$ 600 VIN =12V VIN =18V 400 [F $\underline{\sigma}$ 200 -25 25 55 85 125 $V_{OUT} = 5 V$ Temperature [°C] GIPD261120151226bMT









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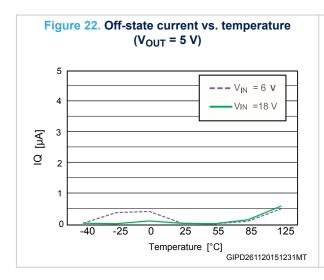
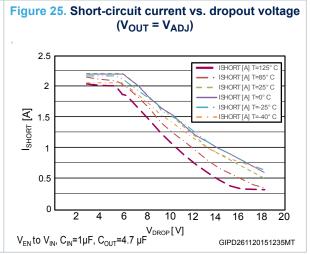
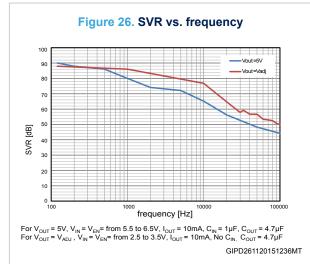
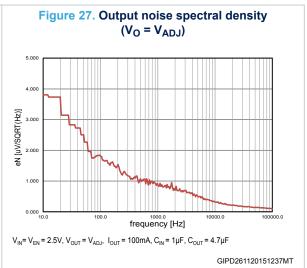


Figure 24. Short-circuit current vs. dropout voltage $(V_{OUT} = 5 V)$ 2.5 ISHORT [A] T=85° C 2 ISHORT [A] T=25° C ISHORT [A] T=0° C ISHORT (A) T=-25° (**≤** 1.5 ISHORT[A] T=40° SHORT 1 0.5 8 10 12 14 16 18 20 V_{EN} to V_{IN} , C_{IN} =1 μ F, C_{OUT} =4.7 μ F GIPD261120151233MT

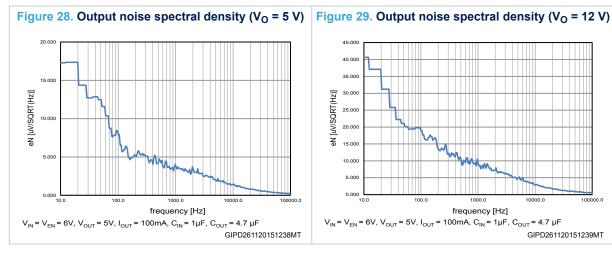


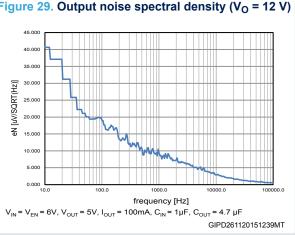


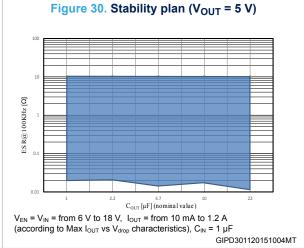


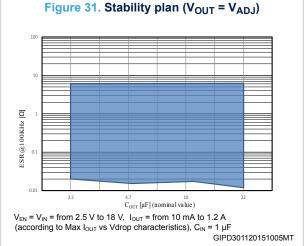
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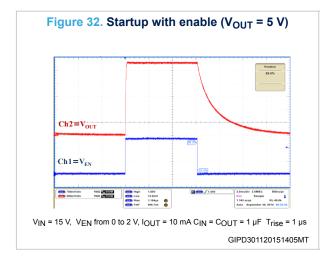


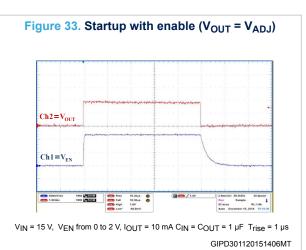






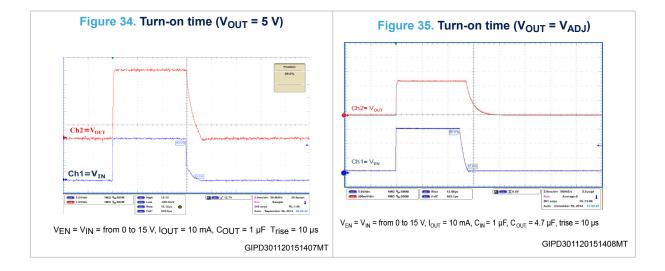


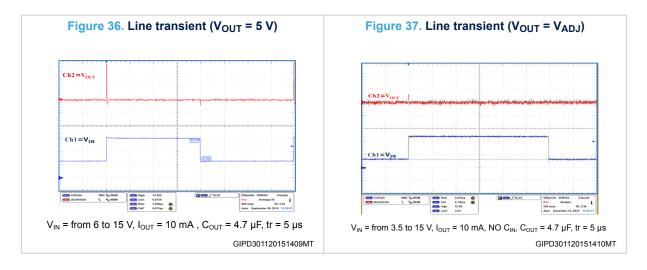


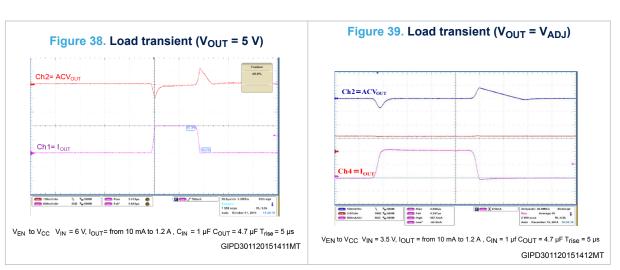


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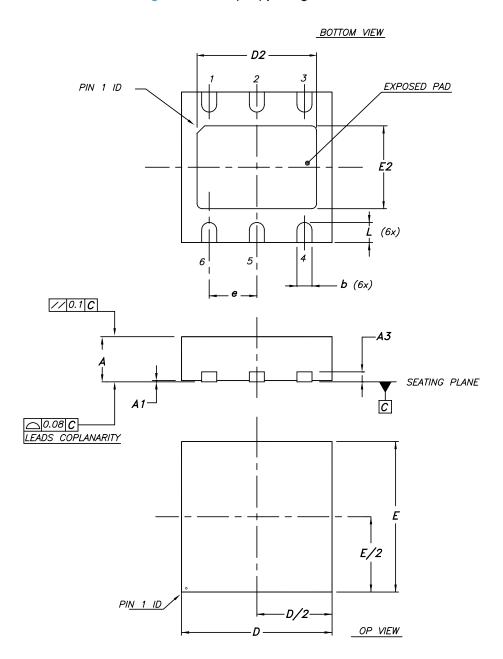


7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

7.1 DFN6 (3x3) package information

Figure 40. DFN6 (3x3) package outline



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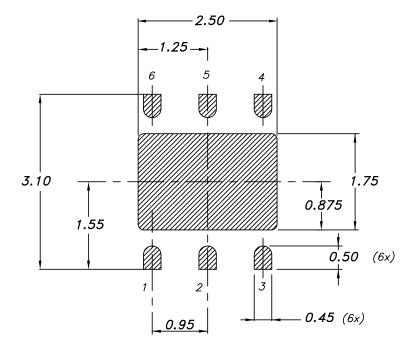


Table 5. DFN6 (3x3) mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	0.80		1
A1	0	0.02	0.05
A3		0.20	
b	0.23		0.45
D	2.90	3	3.10
D2	2.23		2.50
E	2.90	3	3.10
E2	1.50		1.75
е		0.95	
L	0.30	0.40	0.50

Figure 41. DFN6 (3x3) recommended footprint

FOOTPRINT RECOMMENDED



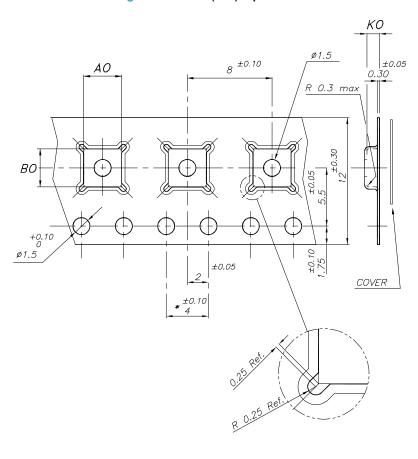
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7.2 DFN6 (3x3) packing information

Figure 42. DFN6 (3x3) tape outline



 $\stackrel{*}{-}$ 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ± 0.20

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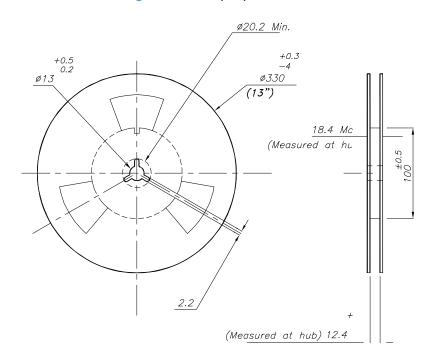


Figure 43. DFN6 (3x3) reel outline

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Table 6. DFN6 (3x3) tape and reel mechanical data

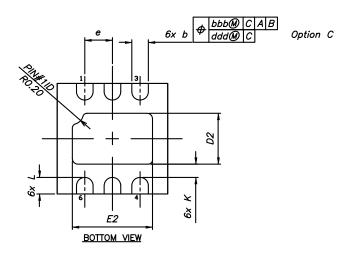
Dim.	mm				
	Min.	Тур.	Max.		
A0	3.20	3.30	3.40		
В0	3.20	3.30	3.40		
K0	1	1.10	1.20		

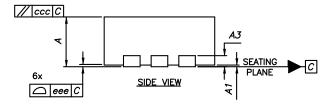
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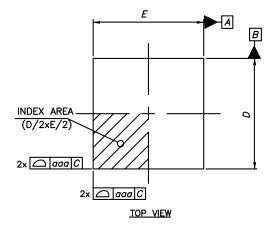


7.3 DFN6 (2x2) package information

Figure 44. DFN6 (2x2) package outline







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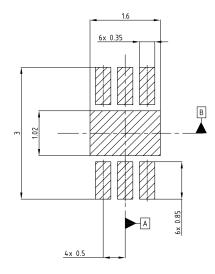
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Table 7. DFN6 (2x2) mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
Α	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	-	0.203 ref	-
b	0.25	0.30	0.35
D	-	2.00	-
E	-	2.00	-
е	-	0.50	-
D2	0.77	0.92	1.02
E2	1.30	1.45	1.55
K	0.15	-	-
L	0.20	0.30	0.40
aaa	-	0.05	-
bbb	-	0.10	-
ccc	-	0.10	-
ddd	-	0.05	-
eee	-	0.08	-

Figure 45. DFN6 (2x2) recommended footprint



Notes:

1) This footprint is able to ensure insulation up to 32 Vrms (according to CEI IEC 664-1)

2) The device must be positioned within \bigcirc 0.02 A B

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7.4 DFN6 (2x2) packing information

Figure 46. DFN6 (2 x 2 mm) reel outline

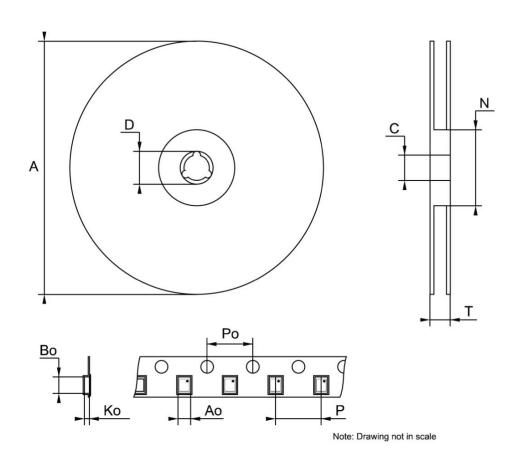


Table 8. DFN6 (2 x 2 mm) tape and reel mechanical data

Dim.		mm	
	Min.	Тур.	Max.
Α			180
С	12.8		13.2
D	20.2		
N	60		
Т			14.4
A0		2.4	
В0		2.4	
K0		1.3	
P0		4	
Р		4	

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7.5 SO8 package information

Figure 47. SO-8 batwing package outline

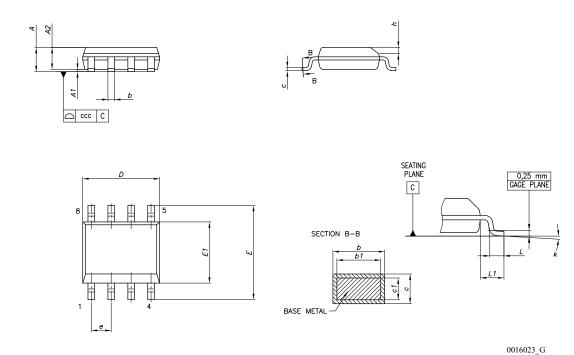


Table 9. SO-8 batwing mechanical data

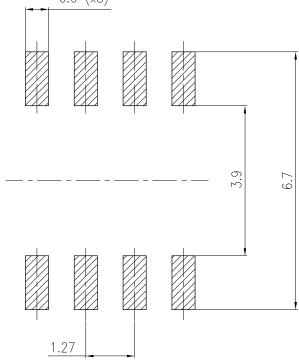
Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
b1	0.28		0.48
С	0.10		0.25
c1	0.10		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
е		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
L2		0.25	
k	0°		8°
CCC			0.10

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0.6 (x8)

Figure 48. SO-8 batwing recommended footprint



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8 Ordering information

Table 10. Order code

DFN6 (3x3)	DFN6 (2x2)	SO-8 batwing plastic micropackage	Output voltage (V)
LDL212PU12R (1)			1.2
LDL212PU15R			1.5
LDL212PU18R (1)			1.8
LDL212PU25R (1)			2.5
LDL212PU30R (1)			3
	LDL212PV33R	LDL212D33R	3.3
LDL212PU50R			5
LDL212PUR	LDL212PVR	LDL212DR	Adjustable

^{1.} Available on request.

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Revision history

Table 11. Document revision history

Date	Revision	Changes
02-Mar-2016	1	Initial release.
19-Sep-2016	2	Updated Table 3: "Thermal data" and Section 5: "Electrical characteristics". Minor text changes.
17-Sep-2018	3	Added: GND pin name in Table 1. Pin description and new order code LDL212D33R in Table 10. Order code.
16-Apr-2019	4	In Table 10. Order code, in LDL2012D33R the note has been removed. Updated GND description in Table 1. Pin description.
21-Feb-2020	5	Added dropout voltage for SO-8 in Table 4. Electrical characteristics.

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